



RF3117

3V 900MHZ LINEAR AMPLIFIER MODULE

Typical Applications

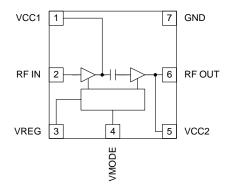
- 3V CDMA/AMPS Cellular Handsets
- 3V CDMA2000/1X Cellular Handsets
- Compatible with Qualcomm Chipset
- Spread-Spectrum Systems

Product Description

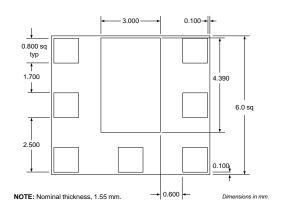
The RF3117 is a high-power, high-efficiency linear amplifier module targeting 3V handheld systems. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as the final RF amplifier in dual-mode 3V CDMA/AMPS handheld digital cellular equipment, spread-spectrum systems, and other applications in the 824MHz to 849MHz band. The RF3117 has a digital control line for low power application to reduce the current drain. The device is self-contained with 50Ω input and output that is matched to obtain optimum power, efficiency, and linearity characteristics. The module is an ultra-small 6mmx6mm land grid array with backside ground.

Optimum Technology Matching® Applied

🗌 Si BJT	🗹 GaAs HBT	GaAs MESFET
Si Bi-CMOS	SiGe HBT	Si CMOS



Functional Block Diagram



Package Style: LGM (6mmx6mm)

Features

- Input/Output Internally Matched @ 50Ω
- Single 3V Supply
- 30dBm Linear Output Power
- 30dB Linear Gain
- 33% Linear Efficiency
- 55mA Idle Current

Ordering Information RF3117 3V 900MHz Linear Amplifier Module RF3117 PCBA Fully Assembled Evaluation Board

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Absolute Maximum Ratings

Rating	Unit
+8.0	V _{DC}
+5.2	V _{DC}
+4.2	V _{DC}
+10	dBm
+3.5	V _{DC}
-30 to +110	°C
-30 to +150	°C
	+8.0 +5.2 +4.2 +10 +3.5 -30 to +110



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Parameter	Specification		Unit	Condition	
Falameter	Min.	Тур.	Max.	Unit	Condition
High Power State					Typical Performance at V_{CC} =3.2V,
-					V _{REG} =3V, T _{AMB} =25°C,
(V _{MODE} Low)					Frequency=824MHz to 849MHz (unless otherwise specified)
Frequency Range	824		849	MHz	(unless otherwise specified)
Linear Gain	27	30	049	dB	
Second Harmonic	21	-35		dBc	
Third Harmonic		-40		dBc	
Maximum Linear Output Power	29	30		dBm	
(CDMA Modulation)	29	50		ubiii	
Total Linear Efficiency		33		%	V _{CC} =3.2V, P _{OUT} =29dBm
					(room temperature)
Adjacent Channel Power		-46.5	-45.0	dBc	ACPR @ 885kHz, P _{OUT} =Max P _{OUT}
Rejection					
		-59	-57	dBc	ACPR @ 1980kHz, P _{OUT} =Max P _{OUT}
Input VSWR		1.8:1			
Output VSWR			10:1		No damage.
			6:1		No oscillations. >-70dBc
Noise Power		-135		dBm/Hz	At 45MHz offset.
Low Bower Ctata					Typical Performance at V _{CC} =3.2V,
Low Power State					V _{REG} =3V, T _{AMB} =25°C,
(V _{MODE} High)					Frequency=824MHz to 849MHz
					(unless otherwise specified)
Frequency Range	824		849	MHz	
Linear Gain	17.5	21		dB	
Second Harmonic		-35		dBc	
Third Harmonic	10	-40		dBc	
Maximum Linear Output Power (CDMA Modulation)	16	20		dBm	
Adjacent Channel Power Rejection		-52	-44	dBc	ACPR @ 885kHz, P _{OUT} =Max P _{OUT}
-		-62	-55	dBc	ACPR @ 1980kHz, P _{OUT} =Max P _{OUT}
Output VSWR			10:1		No damage.
			6:1		No oscillations. >-70dBc

Preliminary

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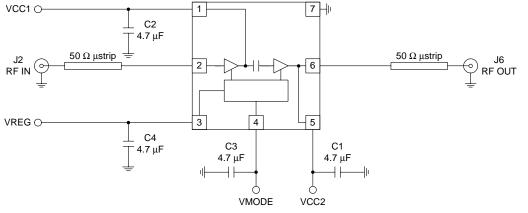
Deremeter	er Specification Unit		Condition		
Parameter	Min.	Тур.	Max.	Unit	Condition
FM Mode					Typical Performance at V_{CC} =3.2V, V_{REG} =3V, T_{AMB} =25°C, Frequency=824MHz to 849MHz (unless otherwise specified)
Frequency Range Gain Second Harmonic Third Harmonic Max CW Output Power	824 31.5	30 -32 -40	849	MHz dB dBc dBc dBm	
Total Efficiency (AMPS mode) Input VSWR Output VSWR		42	<2:1 10:1 6:1	%	P _{OUT} =31.5dBm (room temperature) No damage. No oscillations. >-70dBc
DC Supply					T _{AMB} =25°C
Supply Voltage Range	3.2	3.7	4.2	V	
Quiescent Current		160	240	mA	V_{MODE} =Low, V_{REG} =3V, V_{CC} =3.2V
		55	65	mA	V_{MODE} =High, V_{REG} =3V, V_{CC} =3.2V
V _{REG} Current			10	mA	V _{MODE} =High
V _{MODE} Current			1	mA	
Turn On/Off Time			<40	μs	V_{REG} switch from Low to High, I _{CC} to within 90% of the final value, P _{OUT} within 1 dB of the final value
Total Current (Power Down)		3	10	μA	V _{REG} =Low, V _{MODE} =Low
V _{REG} "Low" Voltage	0		0.5	V	
V _{REG} "High" Voltage	2.9	3.0	3.1	V	
V _{MODE} "Low" Voltage	0		0.5	V	
V _{MODE} "High" Voltage	2.0		3.0	V	

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2	
AMPLIFIERS	
POWER	

Pin	Function	Description	Interface Schematic
1	VCC1	First stage collector supply. A low frequency decoupling capacitor (e.g., $4.7\mu F$) is required.	
2	RF IN	RF input internally matched to 50Ω . This input is internally AC-coupled.	
3	VREG	Regulated voltage supply for amplifier bias. In Power Down mode, both $\rm V_{REG}$ and $\rm V_{MODE}$ need to be LOW (<0.5V).	
4	VMODE	For nominal operation (High Power Mode), V _{MODE} is set LOW. When set HIGH, devices are turned off to improve efficiency.	
5	VCC2	Output stage collector supply. A low frequency decoupling capacitor (e.g., 4.7μ F) is required.	
6	RF OUT	RF output internally matched to 50Ω . This output is internally AC-coupled.	
7	GND	Ground connection. Connect to package base ground. For best perfor- mance, keep traces physically short and connect immediately to ground plane.	
Pkg Base	GND	Ground connection. The backside of the package should be soldered to a top side ground pad which is connected to the ground plane with mul- tiple vias. The pad should have a short thermal path to the ground plane.	

Evaluation Board Schematic (Download <u>Bill of Materials</u> from www.rfmd.com.)



RF3117

Evaluation Board Layout Board Size 1.5" x 1.5" Board Thickness 0.032", Board Material FR-4, Multi-Layer, Ground Plane at 0.014"

